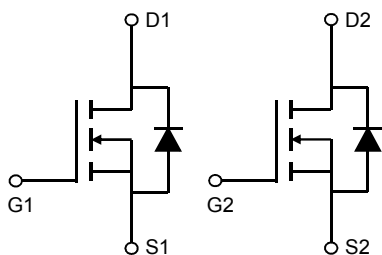
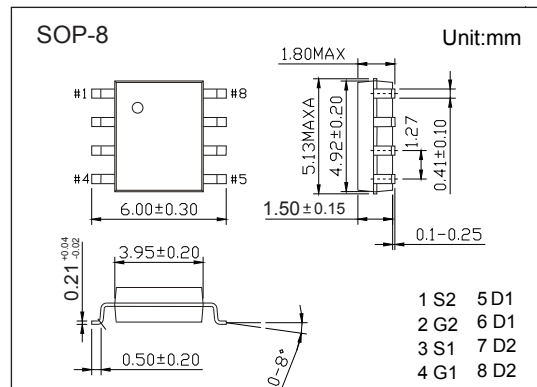


Dual N-Channel MOSFET

AO4892 (KO4892)

■ Features

- $V_{DS} (V) = 100V$
- $I_D = 4A$ ($V_{GS} = 10V$)
- $R_{DS(ON)} < 68m\Omega$ ($V_{GS} = 10V$)
- $R_{DS(ON)} < 94m\Omega$ ($V_{GS} = 4.5V$)

■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter		Symbol	Rating	Unit
Drain-Source Voltage		V_{DS}	100	V
Gate-Source Voltage		V_{GS}	± 20	
Continuous Drain Current	$T_A = 25^\circ C$	I_D	4	A
	$T_A = 70^\circ C$		3	
Pulsed Drain Current		I_{DM}	25	
Avalanche Current		I_{AS}	4	
Avalanche Energy	$L = 0.1mH$	E_{AS}	0.8	mJ
Power Dissipation	$T_A = 25^\circ C$	P_D	2	W
	$T_A = 70^\circ C$		1.3	
Thermal Resistance.Junction- to-Ambient	$t \leq 10s$	R_{thJA}	62.5	$^\circ C/W$
	Steady-State		90	
Thermal Resistance.Junction- to-Lead		R_{thJL}	40	
Junction Temperature		T_J	150	$^\circ C$
Storage Temperature Range		T_{stg}	-55 to 150	

Dual N-Channel MOSFET

AO4892 (K04892)

■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V _{DSS}	I _D =250 μA, V _{GS} =0V	100			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V, V _{GS} =0V			1	μA
		V _{DS} =100V, V _{GS} =0V, T _J =55°C			5	
Gate-Body Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	1.7		2.8	V
Static Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =10V, I _D =4A			68	mΩ
		V _{GS} =10V, I _D =4A T _J =125°C			126	
		V _{GS} =4.5V, I _D =3A			94	
On State Drain Current	I _{D(on)}	V _{GS} =10V, V _{DS} =5A	25			A
Forward Transconductance	g _{FS}	V _{DS} =5V, I _D =4A		12.5		S
Input Capacitance	C _{iss}	V _{GS} =0V, V _{DS} =50V, f=1MHz		415		pF
Output Capacitance	C _{oss}			32		
Reverse Transfer Capacitance	C _{rss}			3		
Gate Resistance	R _g	V _{GS} =0V, V _{DS} =0V, f=1MHz	0.7		2.1	Ω
Total Gate Charge (10V)	Q _g	V _{GS} =10V, V _{DS} =50V, I _D =4A		6.5	12	nC
Total Gate Charge (4.5V)				3	6	
Gate Source Charge	Q _{gs}			1.5		
Gate Drain Charge	Q _{gd}			1.5		
Turn-On DelayTime	t _{d(on)}	V _{GS} =10V, V _{DS} =50V, R _L =12.5Ω, R _{GEN} =3Ω		4		ns
Turn-On Rise Time	t _r			2		
Turn-Off DelayTime	t _{d(off)}			15		
Turn-Off Fall Time	t _f			2		
Body Diode Reverse Recovery Time	t _{rr}	I _F = 4A, di/dt= 500A/us		16		nC
Body Diode Reverse Recovery Charge	Q _{rr}			44		
Maximum Body-Diode Continuous Current	I _S				2.5	A
Diode Forward Voltage	V _{SD}	I _S =1A, V _{GS} =0V			1	V

Note.The static characteristics in Figures 1 to 6 are obtained using <300us pulses, duty cycle 0.5% max.

■ Marking

Marking	4892 KA****
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Dual N-Channel MOSFET

AO4892 (KO4892)

■ Typical Characteristics

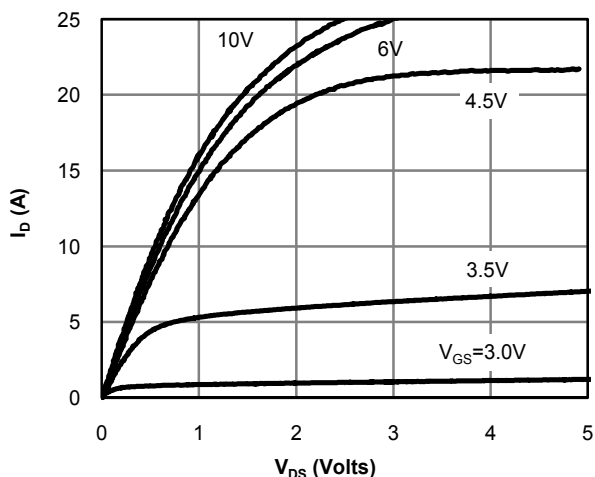


Fig 1: On-Region Characteristics (Note E)

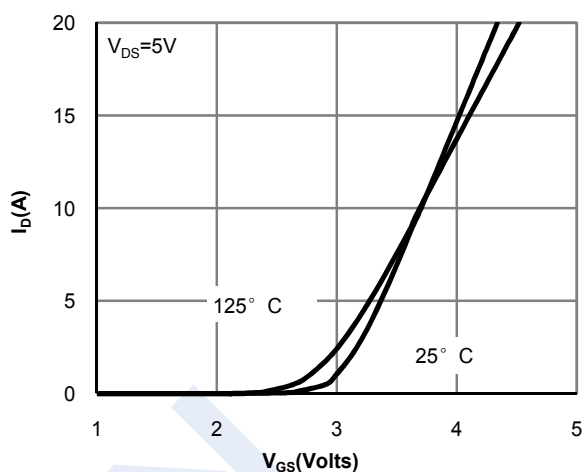


Figure 2: Transfer Characteristics (Note E)

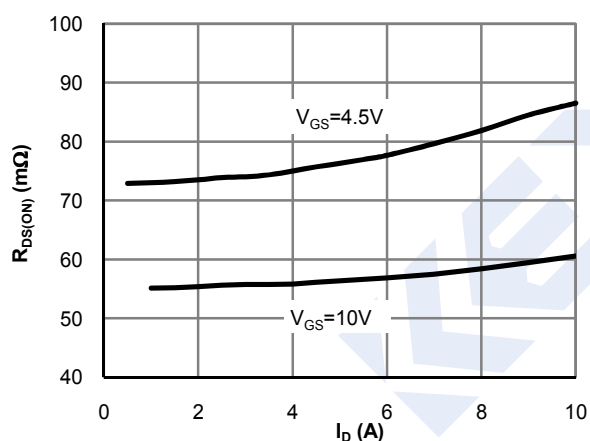


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

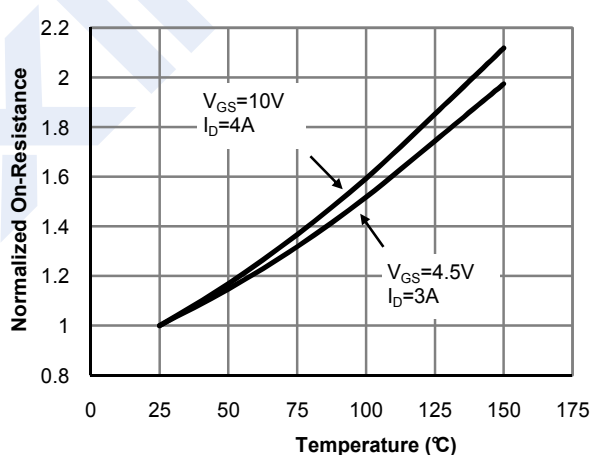


Figure 4: On-Resistance vs. Junction Temperature

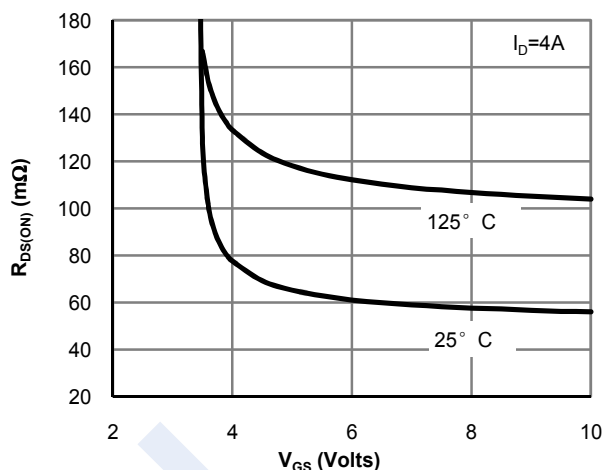


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

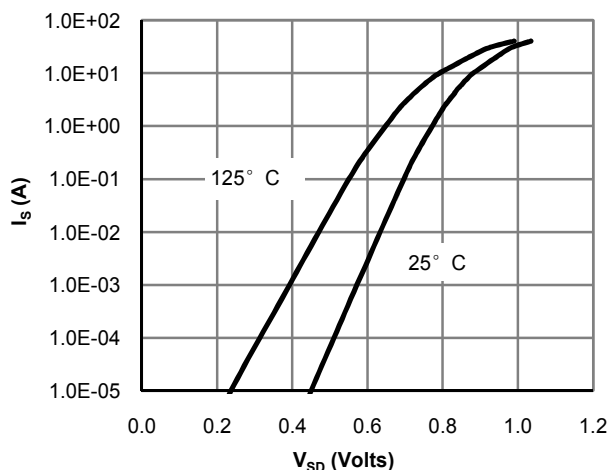


Figure 6: Body-Diode Characteristics (Note E)

Dual N-Channel MOSFET

AO4892 (KO4892)

■ Typical Characteristics

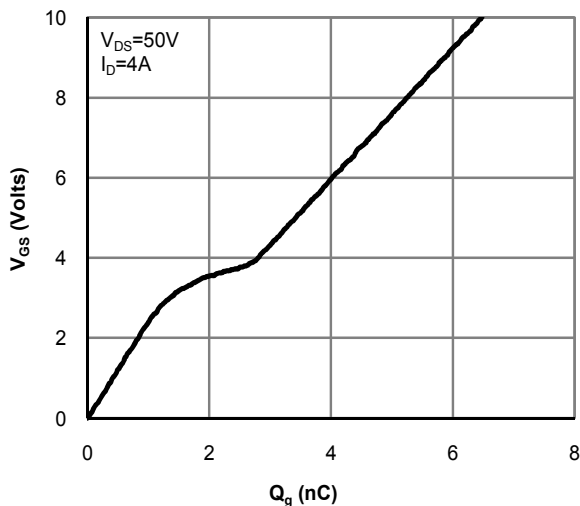


Figure 7: Gate-Charge Characteristics

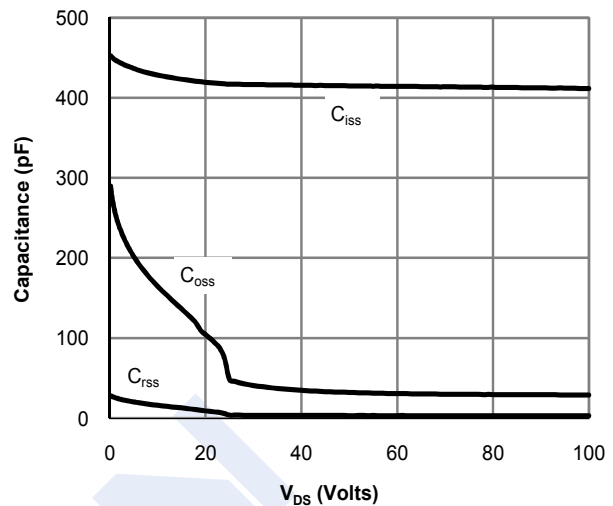


Figure 8: Capacitance Characteristics

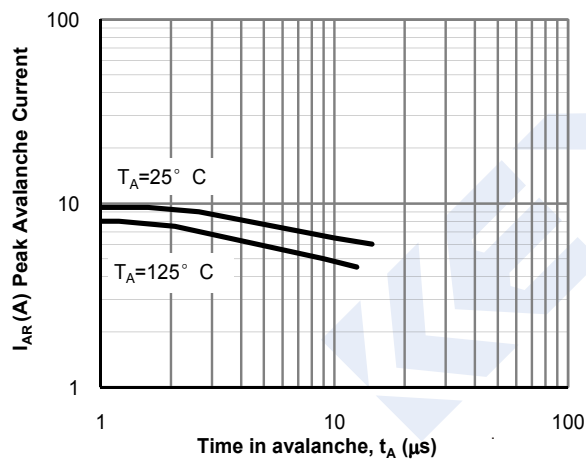


Figure 12: Single Pulse Avalanche capability

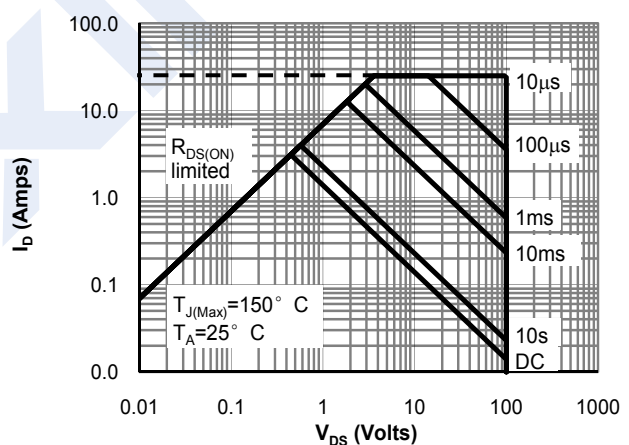


Figure 10: Maximum Forward Biased Safe Operating Area (Note F)

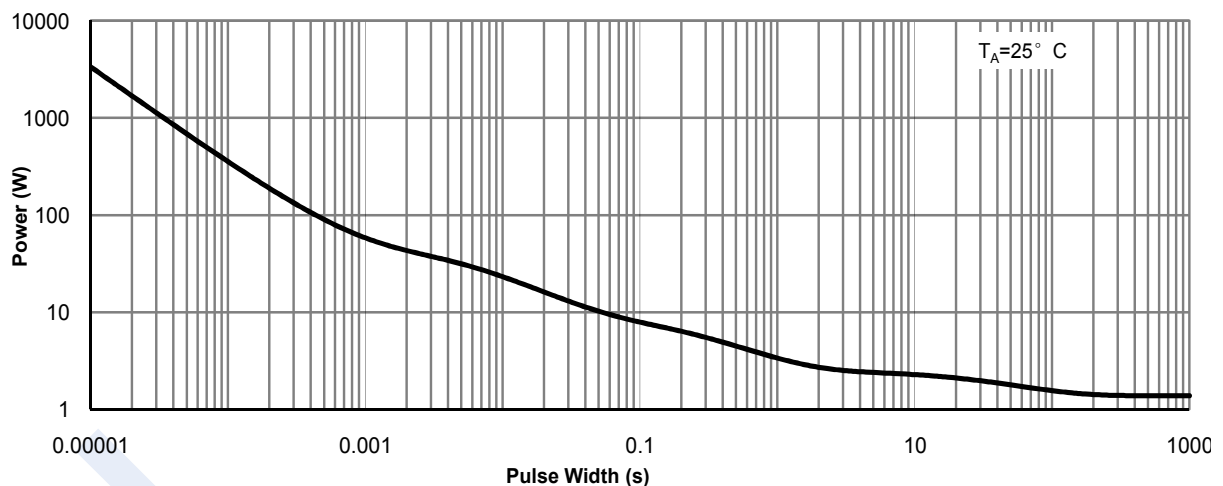


Figure 11: Single Pulse Power Rating Junction-to-Ambient (Note F)

Dual N-Channel MOSFET

AO4892 (KO4892)

■ Typical Characteristics

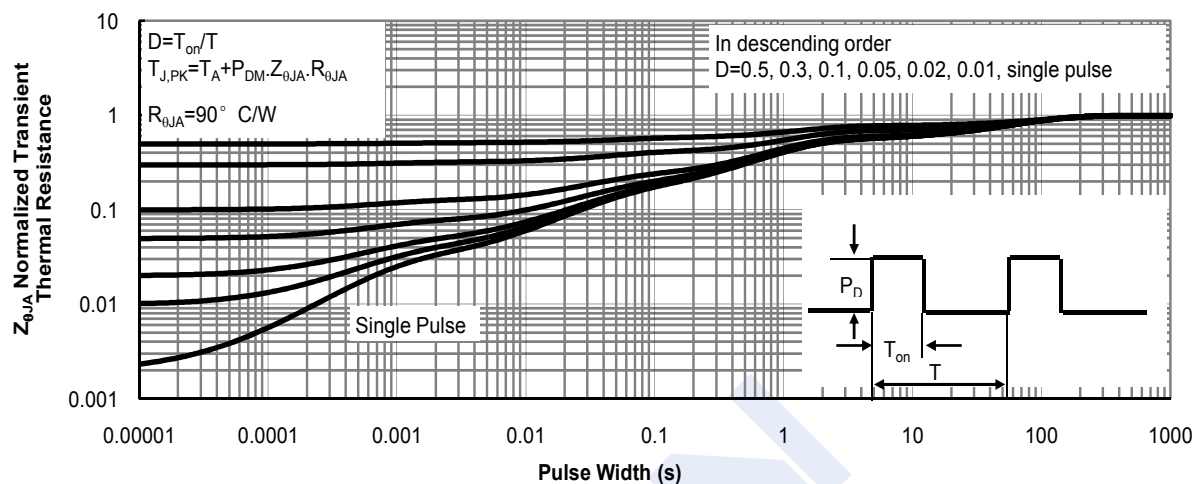


Figure 12: Normalized Maximum Transient Thermal Impedance (Note F)